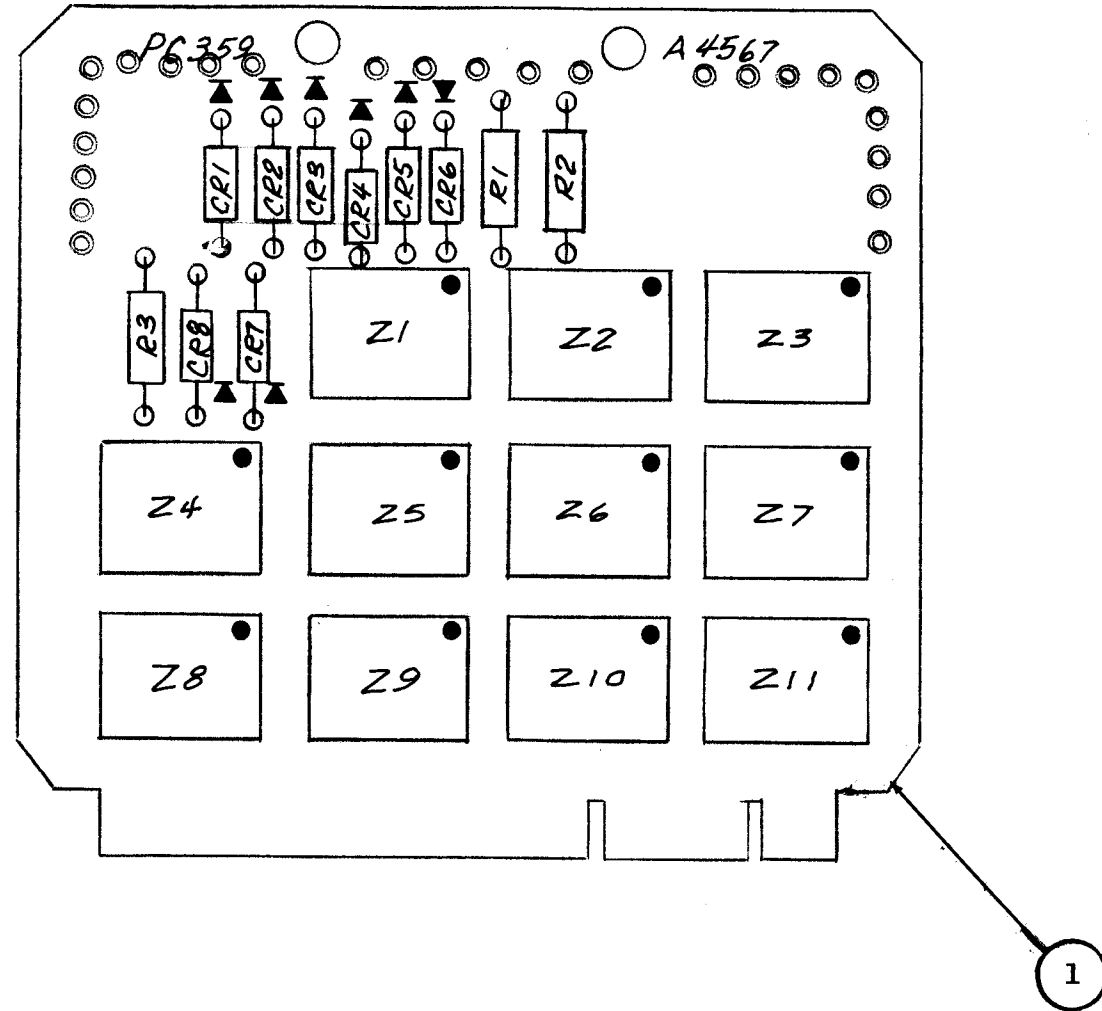


A4567



REVISIONS

SYM	DESCRIPTION	DATE	E.M.N. NO.	DRAFT	CHKD	APPD
Ø	ORIGINAL RELEASE FOR PRODUCTION	8/18/69		W		
A	REDRAWN FROM PHOTO TO LINE DWG	10/25/70	20049	GE	W	P.E.K.

ASSEMBLY NOTES

1. TO MOUNT COMPONENTS INSERT LEAD THROUGH PLATED THRU-HOLES.
2. CAUTION: WHEN APPLYING HEAT AND SOLDER TO LEAD AND FOIL.
3. CLEAN AND INSPECT AS PER TMC SPEC S676.
4. FOR ELECTRICAL COMPONENT PART NUMBERS REFER TO NPL A4567.
5. USE SYMBOL NUMBERS FOR ASSEMBLY REFERENCE.

REQ'D.	ITEM	PART NUMBER	DESCRIPTION	SYMBOL
X	2	BS 100	SOLDER TIN ALLOY	
1	1	PC359	PRINTED CIRCUIT BOARD	

**LIST OF MATERIAL**

MATERIAL	<b>THE TECHNICAL MATERIEL CORP.</b> MAMARONECK, NEW YORK			
FINISH	<b>ASSEMBLY, PC BOARD</b> <b>GATING CIRCUIT</b>			
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES	DRAWN	DATE	FINAL APPROVAL	DATE
	CHECKED	DATE	<b>A 4567</b>	<b>A</b>
DECIMALS .X ± .05 .XX ± .01 .XXX ± .005	TOLERANCES	DATE		
FRACTIONS ± 1/64 ANGLES ± 0° 30'		MECH. DES.	SHEET	

1	RTMU-4( )	
Q'TY./UNIT	MODEL USED ON	ASS'Y. NO.
SCALE	CODE	
	A	2401-451

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NOTES